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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Active
Number of LABs/CLBs	54150
Number of Logic Elements/Cells	693120
Total RAM Bits	54190080
Number of I/O	1000
Number of Gates	-
Voltage - Supply	0.97V ~ 1.03V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1924-BBGA, FCBGA
Supplier Device Package	1930-FCBGA (45x45)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc7vx690t-2ff1930i">https://www.e-xfl.com/product-detail/xilinx/xc7vx690t-2ff1930i</a>

**Table 7** shows the minimum current, in addition to  $I_{CCQ}$ , that is required by Virtex-7 T and XT devices for proper power-on and configuration. If the current minimums shown in **Table 6** and **Table 7** are met, the device powers on after all five supplies have passed through their power-on reset threshold voltages. The FPGA must not be configured until after  $V_{CCINT}$  is applied.

Once initialized and configured, use the XPower tools to estimate current drain on these supplies.

**Table 7: Power-On Current for Virtex-7 T and XT Devices**

Device	$I_{CCINTMIN}$	$I_{CCAUXMIN}$	$I_{CCOMIN}$	$I_{CCAUX\_IO}$	$I_{CCBRAM}$	Units
	$I_{CCINTQ}^{(1)}$	$I_{CCAUXQ}^{(1)}$	$I_{CCOQ}^{(1)}$	$I_{CCOAUQ}^{(1)}$	$I_{CCBRAMQ}^{(1)}$	
XC7V585T	$I_{CCINTQ} + 2700$	$I_{CCAUXQ} + 40$	$I_{CCOQ} + 60 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 108$	mA
XC7V2000T	$I_{CCINTQ} + 4000$	$I_{CCAUXQ} + 80$	$I_{CCOQ} + 60 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 176$	mA
XC7VX330T	$I_{CCINTQ} + 1000$	$I_{CCAUXQ} + 65$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 95$	mA
XC7VX415T	$I_{CCINTQ} + 1200$	$I_{CCAUXQ} + 75$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 115$	mA
XC7VX485T	$I_{CCINTQ} + 1200$	$I_{CCAUXQ} + 80$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 140$	mA
XC7VX550T	$I_{CCINTQ} + 3300$	$I_{CCAUXQ} + 143$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 57 \text{ mA per bank}$	$I_{CCBRAMQ} + 200$	mA
XC7VX690T	$I_{CCINTQ} + 3300$	$I_{CCAUXQ} + 143$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 57 \text{ mA per bank}$	$I_{CCBRAMQ} + 200$	mA
XC7VX980T	$I_{CCINTQ} + 6500$	$I_{CCAUXQ} + 202$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 60 \text{ mA per bank}$	$I_{CCBRAMQ} + 204$	mA
XC7VX1140T	$I_{CCINTQ} + 8000$	$I_{CCAUXQ} + 235$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 63 \text{ mA per bank}$	$I_{CCBRAMQ} + 256$	mA

**Notes:**

1. Typical values are specified at nominal voltage, 25°C.
2. Use the Xilinx Power Estimator (XPE) spreadsheet tool (download at <http://www.xilinx.com/power>) to calculate maximum power-on currents.

**Table 8: Power Supply Ramp Time**

Symbol	Description	Conditions	Min	Max	Units
$T_{VCCINT}$	Ramp time from GND to 90% of $V_{CCINT}$		0.2	50	ms
$T_{VCCO}$	Ramp time from GND to 90% of $V_{CCO}$		0.2	50	ms
$T_{VCCAUX}$	Ramp time from GND to 90% of $V_{CCAUX}$		0.2	50	ms
$T_{VCCAUX\_IO}$	Ramp time from GND to 90% of $V_{CCAUX\_IO}$		0.2	50	ms
$T_{CCBRAM}$	Ramp time from GND to 90% of $V_{CCBRAM}$		0.2	50	ms
$T_{VCCO2VCCAUX}$	Allowed time per power cycle for $V_{CCO} - V_{CCAUX} > 2.625\text{V}$	$T_J = 100^\circ\text{C}^{(1)}$	–	500	ms
		$T_J = 85^\circ\text{C}^{(1)}$	–	800	
$T_{MGTAVCC}$	Ramp time from GND to 90% of $V_{MGTAVCC}$		0.2	50	ms
$T_{MGTAVTT}$	Ramp time from GND to 90% of $V_{MGTAVTT}$		0.2	50	ms
$T_{MGTVCCAUX}$	Ramp time from GND to 90% of $V_{MGTVCCAUX}$		0.2	50	ms

**Notes:**

1. Based on 240,000 power cycles with nominal  $V_{CCO}$  of 3.3V or 36,500 power cycles with a worst case  $V_{CCO}$  of 3.465V.

## DC Input and Output Levels

Values for  $V_{IL}$  and  $V_{IH}$  are recommended input voltages. Values for  $I_{OL}$  and  $I_{OH}$  are guaranteed over the recommended operating conditions at the  $V_{OL}$  and  $V_{OH}$  test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at a minimum  $V_{CCO}$  with the respective  $V_{OL}$  and  $V_{OH}$  voltage levels shown. Other standards are sample tested.

Table 9: SelectIO DC Input and Output Levels<sup>(1)(2)</sup>

I/O Standard	$V_{IL}$		$V_{IH}$		$V_{OL}$	$V_{OH}$	$I_{OL}$	$I_{OH}$
	$V$ , Min	$V$ , Max	$V$ , Min	$V$ , Max	$V$ , Max	$V$ , Min	mA	mA
HSTL_I	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	0.400	$V_{CCO} - 0.400$	8	-8
HSTL_I_12	-0.300	$V_{REF} - 0.080$	$V_{REF} + 0.080$	$V_{CCO} + 0.300$	25% $V_{CCO}$	75% $V_{CCO}$	6.3	-6.3
HSTL_I_18	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	0.400	$V_{CCO} - 0.400$	8	-8
HSTL_II	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	0.400	$V_{CCO} - 0.400$	16	-16
HSTL_II_18	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	0.400	$V_{CCO} - 0.400$	16	-16
HSUL_12	-0.300	$V_{REF} - 0.130$	$V_{REF} + 0.130$	$V_{CCO} + 0.300$	20% $V_{CCO}$	80% $V_{CCO}$	0.1	-0.1
LVCMOS12	-0.300	35% $V_{CCO}$	65% $V_{CCO}$	$V_{CCO} + 0.300$	0.400	$V_{CCO} - 0.400$	Note 3	Note 3
LVCMOS15, LVDCI_15	-0.300	35% $V_{CCO}$	65% $V_{CCO}$	$V_{CCO} + 0.300$	25% $V_{CCO}$	75% $V_{CCO}$	Note 4	Note 4
LVCMOS18, LVDCI_18	-0.300	35% $V_{CCO}$	65% $V_{CCO}$	$V_{CCO} + 0.300$	0.450	$V_{CCO} - 0.450$	Note 5	Note 5
LVCMOS25	-0.300	0.700	1.700	$V_{CCO} + 0.300$	0.400	$V_{CCO} - 0.400$	Note 6	Note 6
LVCMOS33	-0.300	0.800	2.000	3.450	0.400	$V_{CCO} - 0.400$	Note 6	Note 6
LVTTL	-0.300	0.800	2.000	3.450	0.400	2.400	Note 7	Note 7
MOBILE_DDR	-0.300	20% $V_{CCO}$	80% $V_{CCO}$	$V_{CCO} + 0.300$	10% $V_{CCO}$	90% $V_{CCO}$	0.1	-0.1
PCI33_3	-0.400	30% $V_{CCO}$	50% $V_{CCO}$	$V_{CCO} + 0.500$	10% $V_{CCO}$	90% $V_{CCO}$	1.5	-0.5
SSTL12	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.150$	$V_{CCO}/2 + 0.150$	14.25	-14.25
SSTL135	-0.300	$V_{REF} - 0.090$	$V_{REF} + 0.090$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.150$	$V_{CCO}/2 + 0.150$	13.0	-13.0
SSTL135_R	-0.300	$V_{REF} - 0.090$	$V_{REF} + 0.090$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.150$	$V_{CCO}/2 + 0.150$	8.9	-8.9
SSTL15	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.175$	$V_{CCO}/2 + 0.175$	13.0	-13.0
SSTL15_R	-0.300	$V_{REF} - 0.100$	$V_{REF} + 0.100$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.175$	$V_{CCO}/2 + 0.175$	8.9	-8.9
SSTL18_I	-0.300	$V_{REF} - 0.125$	$V_{REF} + 0.125$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.470$	$V_{CCO}/2 + 0.470$	8	-8
SSTL18_II	-0.300	$V_{REF} - 0.125$	$V_{REF} + 0.125$	$V_{CCO} + 0.300$	$V_{CCO}/2 - 0.600$	$V_{CCO}/2 + 0.600$	13.4	-13.4

### Notes:

- Tested according to relevant specifications.
- 3.3V and 2.5V standards are only supported in 3.3V I/O banks.
- Supported drive strengths of 2, 4, 6, or 8 mA in HP I/O banks and 4, 8, or 12 mA in HR I/O banks.
- Supported drive strengths of 2, 4, 6, 8, 12, or 16 mA in HP I/O banks and 4, 8, 12, or 16 mA in HR I/O banks.
- Supported drive strengths of 2, 4, 6, 8, 12, or 16 mA in HP I/O banks and 4, 8, 12, 16, or 24 mA in HR I/O banks.
- Supported drive strengths of 4, 8, 12, or 16 mA
- Supported drive strengths of 4, 8, 12, 16, or 24 mA
- For detailed interface specific DC voltage levels, see the 7 Series FPGAs SelectIO Resources User Guide ([UG471](#)).

## Speed Grade Designations

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device. [Table 15](#) correlates the current status of each Virtex-7 T and XT device on a per speed grade basis.

[Table 15: Virtex-7 T and XT Device Speed Grade Designations](#)

Device	Speed Grade Designations		
	Advance	Preliminary	Production
XC7V585T			-3, -2, -2L, -1
XC7V2000T	-2L, -2G		-2, -1
XC7VX330T			-3, -2, -2L, -1
XC7VX415T			-3, -2, -2L, -1
XC7VX485T			-3, -2, -2L, -1
XC7VX550T			-3, -2, -2L, -1
XC7VX690T			-3, -2, -2L, -1
XC7VX980T	-2, -2L, -1		
XC7VX1140T	-2, -2L, -2G, -1		

## Production Silicon and Software Status

In some cases, a particular family member (and speed grade) is released to production before a speed specification is released with the correct label (Advance, Preliminary, Production). Any labeling discrepancies are corrected in subsequent speed specification releases.

[Table 16](#) lists the production released Virtex-7 T and XT device, speed grade, and the minimum corresponding supported speed specification version and software revisions. The software and speed specifications listed are the minimum releases required for production. All subsequent releases of software and speed specifications are valid.

[Table 16: Virtex-7 T and XT Device Production Software and Speed Specification Release](#)

Device	Speed Grade Designations				
	-3	-2G	-2	-2L	-1
XC7V585T	Vivado 2012.4 v1.08 or ISE 14.2 v1.06	N/A	Vivado 2012.4 v1.08 or ISE 14.2 v1.06		
XC7V2000T	N/A		Vivado 2012.4 v1.07		Vivado 2012.4 v1.07
XC7VX330T	Vivado 2013.1 v1.08 or ISE 14.5 v1.08	N/A	Vivado 2013.1 v1.08 or ISE 14.5 v1.08		
XC7VX415T		N/A			
XC7VX485T	Vivado 2012.4 v1.08 or ISE 14.2 v1.06	N/A	Vivado 2012.4 v1.08 or ISE 14.2 v1.06		
XC7VX550T	Vivado 2013.1 v1.08 or ISE 14.5 v1.08	N/A	Vivado 2013.1 v1.08 or ISE 14.5 v1.08		
XC7VX690T	Vivado 2013.1 v1.08 or ISE 14.5 v1.08	N/A	Vivado 2013.1 v1.08 or ISE 14.5 v1.08		
XC7VX980T	N/A	N/A			
XC7VX1140T	N/A				

### Notes:

- Blank entries indicate a device and/or speed grade in advance or preliminary status.

## IOB Pad Input/Output/3-State

**Table 19** (3.3V high-range IOB (HR)) and **Table 20** (1.8V high-performance IOB (HP)) summarizes the values of standard-specific data input delay adjustments, output delays terminating at pads (based on standard) and 3-state delays.

- $T_{IOPI}$  is described as the delay from IOB pad through the input buffer to the I-pin of an IOB pad. The delay varies depending on the capability of the SelectIO input buffer.
- $T_{IOOP}$  is described as the delay from the O pin to the IOB pad through the output buffer of an IOB pad. The delay varies depending on the capability of the SelectIO output buffer.
- $T_{IOTP}$  is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is disabled. The delay varies depending on the SelectIO capability of the output buffer. In HP I/O banks, the internal DCI termination turn-on time is always faster than  $T_{IOTP}$  when the DCITERMDISABLE pin is used. In HR I/O banks, the IN\_TERM termination turn-on time is always faster than  $T_{IOTP}$  when the INTERMDISABLE pin is used.

Table 19: 3.3V IOB High Range (HR) Switching Characteristics

I/O Standard	$T_{IOPI}$			$T_{IOOP}$			$T_{IOTP}$			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
LVTTL_S4	1.31	1.42	1.64	3.77	3.90	4.00	4.53	4.76	4.99	ns	
LVTTL_S8	1.31	1.42	1.64	3.50	3.64	3.73	4.26	4.50	4.72	ns	
LVTTL_S12	1.31	1.42	1.64	3.49	3.62	3.72	4.25	4.48	4.71	ns	
LVTTL_S16	1.31	1.42	1.64	3.03	3.17	3.26	3.79	4.03	4.25	ns	
LVTTL_S24	1.31	1.42	1.64	3.25	3.39	3.48	4.01	4.25	4.47	ns	
LVTTL_F4	1.31	1.42	1.64	3.22	3.36	3.45	3.98	4.22	4.44	ns	
LVTTL_F8	1.31	1.42	1.64	2.71	2.84	2.93	3.47	3.70	3.92	ns	
LVTTL_F12	1.31	1.42	1.64	2.69	2.82	2.92	3.45	3.68	3.91	ns	
LVTTL_F16	1.31	1.42	1.64	2.57	2.85	3.15	3.33	3.71	4.14	ns	
LVTTL_F24	1.31	1.42	1.64	2.41	2.64	2.89	3.17	3.50	3.88	ns	
LVDS_25 <sup>(1)</sup>	0.64	0.68	0.80	1.36	1.47	1.55	2.12	2.33	2.54	ns	
MINI_LVDS_25	0.68	0.70	0.79	1.36	1.47	1.55	2.12	2.33	2.54	ns	
BLVDS_25 <sup>(1)</sup>	0.65	0.69	0.80	1.83	2.02	2.20	2.59	2.88	3.19	ns	
RSDS_25 (point to point) <sup>(1)</sup>	0.63	0.68	0.79	1.36	1.48	1.55	2.12	2.34	2.54	ns	
PPDS_25 <sup>(1)</sup>	0.65	0.69	0.80	1.36	1.49	1.58	2.12	2.35	2.57	ns	
TMDS_33 <sup>(1)</sup>	0.72	0.76	0.86	1.43	1.54	1.60	2.19	2.40	2.59	ns	
PCI33_3 <sup>(1)</sup>	1.28	1.41	1.65	2.71	3.08	3.52	3.47	3.94	4.51	ns	
HSUL_12	0.63	0.64	0.71	1.77	1.90	2.00	2.53	2.76	2.99	ns	
DIFF_HSUL_12	0.58	0.61	0.70	1.55	1.68	1.78	2.31	2.54	2.77	ns	
HSTL_I_S	0.61	0.64	0.73	1.55	1.69	1.80	2.31	2.55	2.79	ns	
HSTL_II_S	0.61	0.64	0.73	1.21	1.34	1.43	1.97	2.20	2.42	ns	
HSTL_I_18_S	0.64	0.67	0.76	1.28	1.39	1.45	2.04	2.25	2.44	ns	
HSTL_II_18_S	0.64	0.67	0.76	1.18	1.31	1.40	1.94	2.17	2.39	ns	
DIFF_HSTL_I_S	0.63	0.67	0.77	1.42	1.54	1.61	2.18	2.40	2.60	ns	
DIFF_HSTL_II_S	0.63	0.67	0.77	1.15	1.24	1.27	1.91	2.10	2.26	ns	
DIFF_HSTL_I_18_S	0.65	0.69	0.78	1.27	1.38	1.43	2.03	2.24	2.42	ns	
DIFF_HSTL_II_18_S	0.65	0.69	0.78	1.14	1.23	1.26	1.90	2.09	2.25	ns	
HSTL_I_F	0.61	0.64	0.73	1.10	1.19	1.23	1.86	2.05	2.22	ns	

## Input/Output Logic Switching Characteristics

Table 22: ILOGIC Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Setup/Hold</b>					
T <sub>ICE1CK/T<sub>ICKCE1</sub></sub>	CE1 pin setup/hold with respect to CLK	0.42/0.00	0.48/0.00	0.67/0.00	ns
T <sub>ISRCK/T<sub>ICKSR</sub></sub>	SR pin setup/hold with respect to CLK	0.53/0.01	0.61/0.01	0.99/0.01	ns
T <sub>IDOCKE2/T<sub>IOCKDE2</sub></sub>	D pin setup/hold with respect to CLK without delay (HP I/O banks only)	0.01/0.27	0.01/0.29	0.01/0.34	ns
T <sub>IDOCKDE2/T<sub>IOCKDDE2</sub></sub>	DDLY pin setup/hold with respect to CLK (using IDELAY) (HP I/O banks only)	0.01/0.27	0.02/0.29	0.02/0.34	ns
T <sub>IDOCKE3/T<sub>IOCKDE3</sub></sub>	D pin setup/hold with respect to CLK without delay (HR I/O banks only)	0.01/0.27	0.01/0.29	0.01/0.34	ns
T <sub>IDOCKDE3/T<sub>IOCKDDE3</sub></sub>	DDLY pin setup/hold with respect to CLK (using IDELAY) (HR I/O banks only)	0.01/0.27	0.02/0.29	0.02/0.34	ns
<b>Combinatorial</b>					
T <sub>IDIE2</sub>	D pin to O pin propagation delay, no delay (HP I/O banks only)	0.09	0.10	0.12	ns
T <sub>IDIDE2</sub>	DDLY pin to O pin propagation delay (using IDELAY) (HP I/O banks only)	0.10	0.11	0.13	ns
T <sub>IDIE3</sub>	D pin to O pin propagation delay, no delay (HR I/O banks only)	0.09	0.10	0.12	ns
T <sub>IDIDE3</sub>	DDLY pin to O pin propagation delay (using IDELAY) (HR I/O banks only)	0.10	0.11	0.13	ns
<b>Sequential Delays</b>					
T <sub>IDLOE2</sub>	D pin to Q1 pin using flip-flop as a latch without delay (HP I/O banks only)	0.36	0.39	0.45	ns
T <sub>IDLODE2</sub>	DDLY pin to Q1 pin using flip-flop as a latch (using IDELAY) (HP I/O banks only)	0.36	0.39	0.45	ns
T <sub>IDLOE3</sub>	D pin to Q1 pin using flip-flop as a latch without delay (HR I/O banks only)	0.36	0.39	0.45	ns
T <sub>IDLODE3</sub>	DDLY pin to Q1 pin using flip-flop as a latch (using IDELAY) (HR I/O banks only)	0.36	0.39	0.45	ns
T <sub>ICKQ</sub>	CLK to Q outputs	0.47	0.50	0.58	ns
T <sub>RQ_ILOGICE2</sub>	SR pin to OQ/TQ out (HP I/O banks only)	0.84	0.94	1.16	ns
T <sub>GSRQ_ILOGICE2</sub>	Global set/reset to Q outputs (HP I/O banks only)	7.60	7.60	10.51	ns
T <sub>RQ_ILOGICE3</sub>	SR pin to OQ/TQ out (HR I/O banks only)	0.84	0.94	1.16	ns
T <sub>GSRQ_ILOGICE3</sub>	Global set/reset to Q outputs (HR I/O banks only)	7.60	7.60	10.51	ns
<b>Set/Reset</b>					
T <sub>RPW_ILOGICE2</sub>	Minimum pulse width, SR inputs (HP I/O banks only)	0.54	0.63	0.63	ns, Min
T <sub>RPW_ILOGICE3</sub>	Minimum pulse width, SR inputs (HR I/O banks only)	0.54	0.63	0.63	ns, Min

## Input Serializer/Deserializer Switching Characteristics

Table 24: ISERDES Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Setup/Hold for Control Lines</b>					
T <sub>ISCKC_BITSILIP</sub> /T <sub>ISCKC_BITSILIP</sub>	BITSILIP pin setup/hold with respect to CLKDIV	0.01/0.12	0.02/0.13	0.02/0.15	ns
T <sub>ISCKC_CE</sub> / T <sub>ISCKC_CE</sub> <sup>(2)</sup>	CE pin setup/hold with respect to CLK (for CE1)	0.39/-0.02	0.44/-0.02	0.63/-0.02	ns
T <sub>ISCKC_CE2</sub> / T <sub>ISCKC_CE2</sub> <sup>(2)</sup>	CE pin setup/hold with respect to CLKDIV (for CE2)	-0.12/0.29	-0.12/0.31	-0.12/0.35	ns
<b>Setup/Hold for Data Lines</b>					
T <sub>ISDCK_D</sub> / T <sub>ISCKD_D</sub>	D pin setup/hold with respect to CLK	-0.02/0.11	-0.02/0.12	-0.02/0.15	ns
T <sub>ISDCK_DDLY</sub> / T <sub>ISCKD_DDLY</sub>	DDLY pin setup/hold with respect to CLK (using IDELAY) <sup>(1)</sup>	-0.02/0.11	-0.02/0.12	-0.02/0.15	ns
T <sub>ISDCK_D_DDR</sub> / T <sub>ISCKD_D_DDR</sub>	D pin setup/hold with respect to CLK at DDR mode	-0.02/0.11	-0.02/0.12	-0.02/0.15	ns
T <sub>ISDCK_DDLY_DDR</sub> / T <sub>ISCKD_DDLY_DDR</sub>	D pin setup/hold with respect to CLK at DDR mode (using IDELAY) <sup>(1)</sup>	0.11/0.11	0.12/0.12	0.15/0.15	ns
<b>Sequential Delays</b>					
T <sub>ISCKO_Q</sub>	CLKDIV to out at Q pin	0.46	0.47	0.58	ns
<b>Propagation Delays</b>					
T <sub>ISDO_DO</sub>	D input to DO output pin	0.09	0.10	0.12	ns

**Notes:**

1. Recorded at 0 tap value.
2. T<sub>ISCKC\_CE2</sub> and T<sub>ISCKC\_CE2</sub> are reported as T<sub>ISCKC\_CE</sub>/T<sub>ISCKC\_CE</sub> in the timing report.

## CLB Switching Characteristics

Table 28: CLB Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Combinatorial Delays</b>					
T <sub>ILO</sub>	An – Dn LUT address to A	0.05	0.05	0.06	ns, Max
T <sub>ILO_2</sub>	An – Dn LUT address to AMUX/CMUX	0.15	0.16	0.19	ns, Max
T <sub>ILO_3</sub>	An – Dn LUT address to BMUX_A	0.24	0.25	0.30	ns, Max
T <sub>ITO</sub>	An – Dn inputs to A – D Q outputs	0.58	0.61	0.74	ns, Max
T <sub>AXA</sub>	AX inputs to AMUX output	0.38	0.40	0.49	ns, Max
T <sub>AXB</sub>	AX inputs to BMUX output	0.40	0.42	0.52	ns, Max
T <sub>AXC</sub>	AX inputs to CMUX output	0.39	0.41	0.50	ns, Max
T <sub>AXD</sub>	AX inputs to DMUX output	0.43	0.44	0.52	ns, Max
T <sub>BXB</sub>	BX inputs to BMUX output	0.31	0.33	0.40	ns, Max
T <sub>BXD</sub>	BX inputs to DMUX output	0.38	0.39	0.47	ns, Max
T <sub>CXC</sub>	CX inputs to CMUX output	0.27	0.28	0.34	ns, Max
T <sub>CXD</sub>	CX inputs to DMUX output	0.33	0.34	0.41	ns, Max
T <sub>DXD</sub>	DX inputs to DMUX output	0.32	0.33	0.40	ns, Max
<b>Sequential Delays</b>					
T <sub>CKO</sub>	Clock to AQ – DQ outputs	0.26	0.27	0.32	ns, Max
T <sub>SHCKO</sub>	Clock to AMUX – DMUX outputs	0.32	0.32	0.39	ns, Max
<b>Setup and Hold Times of CLB Flip-Flops Before/After Clock CLK</b>					
T <sub>AS/T<sub>AH</sub></sub>	A <sub>N</sub> – D <sub>N</sub> input to CLK on A – D flip-flops	0.01/0.12	0.02/0.13	0.03/0.18	ns, Min
T <sub>DICK/T<sub>CKDI</sub></sub>	A <sub>X</sub> – D <sub>X</sub> input to CLK on A – D flip-flops	0.04/0.14	0.04/0.14	0.05/0.20	ns, Min
	A <sub>X</sub> – D <sub>X</sub> input through MUXs and/or carry logic to CLK on A – D flip-flops	0.36/0.10	0.37/0.11	0.46/0.16	ns, Min
T <sub>CECK_CLB/T<sub>CKCE_CLB</sub></sub>	CE input to CLK on A – D flip-flops	0.19/0.05	0.20/0.05	0.25/0.05	ns, Min
T <sub>SRCK/T<sub>CKSR</sub></sub>	SR input to CLK on A – D flip-flops	0.30/0.05	0.31/0.07	0.37/0.09	ns, Min
<b>Set/Reset</b>					
T <sub>SRMIN</sub>	SR input minimum pulse width	0.52	0.78	1.04	ns, Min
T <sub>RQ</sub>	Delay from SR input to AQ – DQ flip-flops	0.38	0.38	0.46	ns, Max
T <sub>CEO</sub>	Delay from CE input to AQ – DQ flip-flops	0.34	0.35	0.43	ns, Max
F <sub>TOG</sub>	Toggle frequency (for export control)	1818	1818	1818	MHz

Table 32: DSP48E1 Switching Characteristics (Cont'd)

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
T <sub>DSPDO_A_P</sub>	A input to P output not using multiplier	1.30	1.48	1.76	ns
T <sub>DSPDO_C_P</sub>	C input to P output	1.13	1.30	1.55	ns
<b>Combinatorial Delays from Input Pins to Cascading Output Pins</b>					
T <sub>DSPDO_{A; B}_{ACOUT; BCOUT}</sub>	{A, B} input to {ACOUT, BCOUT} output	0.47	0.53	0.63	ns
T <sub>DSPDO_{A, B}_CARRYCASCOU_MULT</sub>	{A, B} input to CARRYCASCOU output using multiplier	3.44	3.94	4.69	ns
T <sub>DSPDO_D_CARRYCASCOU_MULT</sub>	D input to CARRYCASCOU output using multiplier	3.36	3.85	4.58	ns
T <sub>DSPDO_{A, B}_CARRYCASCOU</sub>	{A, B} input to CARRYCASCOU output not using multiplier	1.50	1.72	2.04	ns
T <sub>DSPDO_C_CARRYCASCOU</sub>	C input to CARRYCASCOU output	1.34	1.53	1.83	ns
<b>Combinatorial Delays from Cascading Input Pins to All Output Pins</b>					
T <sub>DSPDO_ACIN_P_MULT</sub>	ACIN input to P output using multiplier	3.09	3.55	4.24	ns
T <sub>DSPDO_ACIN_P</sub>	ACIN input to P output not using multiplier	1.16	1.33	1.59	ns
T <sub>DSPDO_ACIN_ACOUT</sub>	ACIN input to ACOUT output	0.32	0.37	0.45	ns
T <sub>DSPDO_ACIN_CARRYCASCOU_MULT</sub>	ACIN input to CARRYCASCOU output using multiplier	3.30	3.79	4.52	ns
T <sub>DSPDO_ACIN_CARRYCASCOU</sub>	ACIN input to CARRYCASCOU output not using multiplier	1.37	1.57	1.87	ns
T <sub>DSPDO_PCIN_P</sub>	PCIN input to P output	0.94	1.08	1.29	ns
T <sub>DSPDO_PCIN_CARRYCASCOU</sub>	PCIN input to CARRYCASCOU output	1.15	1.32	1.57	ns
<b>Clock to Outs from Output Register Clock to Output Pins</b>					
T <sub>DSPCKO_P_PREG</sub>	CLK PREG to P output	0.33	0.35	0.39	ns
T <sub>DSPCKO_CARRYCASCOU_PREG</sub>	CLK PREG to CARRYCASCOU output	0.44	0.50	0.59	ns
<b>Clock to Outs from Pipeline Register Clock to Output Pins</b>					
T <sub>DSPCKO_P_MREG</sub>	CLK MREG to P output	1.42	1.64	1.96	ns
T <sub>DSPCKO_CARRYCASCOU_MREG</sub>	CLK MREG to CARRYCASCOU output	1.63	1.87	2.24	ns
T <sub>DSPCKO_P_ADREG_MULT</sub>	CLK ADREG to P output using multiplier	2.30	2.63	3.13	ns
T <sub>DSPCKO_CARRYCASCOU_ADREG_MULT</sub>	CLK ADREG to CARRYCASCOU output using multiplier	2.51	2.87	3.41	ns
<b>Clock to Outs from Input Register Clock to Output Pins</b>					
T <sub>DSPCKO_P_AREG_MULT</sub>	CLK AREG to P output using multiplier	3.34	3.83	4.55	ns
T <sub>DSPCKO_P_BREG</sub>	CLK BREG to P output not using multiplier	1.39	1.59	1.88	ns
T <sub>DSPCKO_P_CREG</sub>	CLK CREG to P output not using multiplier	1.43	1.64	1.95	ns
T <sub>DSPCKO_P_DREG_MULT</sub>	CLK DREG to P output using multiplier	3.32	3.80	4.51	ns

## PLL Switching Characteristics

Table 39: PLL Specification

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
PLL_F <sub>INMAX</sub>	Maximum input clock frequency	1066.00	933.00	800.00	MHz
PLL_F <sub>INMIN</sub>	Minimum input clock frequency	19.00	19.00	19.00	MHz
PLL_F <sub>INJITTER</sub>	Maximum input clock period jitter	< 20% of clock input period or 1 ns Max			
PLL_F <sub>INDUTY</sub>	Allowable input duty cycle: 19—49 MHz	25	25	25	%
	Allowable input duty cycle: 50—199 MHz	30	30	30	%
	Allowable input duty cycle: 200—399 MHz	35	35	35	%
	Allowable input duty cycle: 400—499 MHz	40	40	40	%
	Allowable input duty cycle: >500 MHz	45	45	45	%
PLL_F <sub>VCOMIN</sub>	Minimum PLL VCO frequency	800.00	800.00	800.00	MHz
PLL_F <sub>VCOMAX</sub>	Maximum PLL VCO frequency	2133.00	1866.00	1600.00	MHz
PLL_F <sub>BANDWIDTH</sub>	Low PLL bandwidth at typical <sup>(1)</sup>	1.00	1.00	1.00	MHz
	High PLL bandwidth at typical <sup>(1)</sup>	4.00	4.00	4.00	MHz
PLL_T <sub>STATPHAOFFSET</sub>	Static phase offset of the PLL outputs <sup>(2)</sup>	0.12	0.12	0.12	ns
PLL_T <sub>OUTJITTER</sub>	PLL output jitter	Note 3			
PLL_T <sub>OUTDUTY</sub>	PLL output clock duty cycle precision <sup>(4)</sup>	0.20	0.20	0.20	ns
PLL_T <sub>LOCKMAX</sub>	PLL maximum lock time	100	100	100	μs
PLL_F <sub>OUTMAX</sub>	PLL maximum output frequency	1066.00	933.00	800.00	MHz
PLL_F <sub>OUTMIN</sub>	PLL minimum output frequency <sup>(5)</sup>	6.25	6.25	6.25	MHz
PLL_T <sub>EXTFDVAR</sub>	External clock feedback variation	< 20% of clock input period or 1 ns Max			
PLL_RST <sub>MINPULSE</sub>	Minimum reset pulse width	5.00	5.00	5.00	ns
PLL_F <sub>PFDMAX</sub>	Maximum frequency at the phase frequency detector	550.00	500.00	450.00	MHz
PLL_F <sub>PFDMIN</sub>	Minimum frequency at the phase frequency detector	19.00	19.00	19.00	MHz
PLL_T <sub>FBDELAY</sub>	Maximum delay in the feedback path	3 ns Max or one CLKIN cycle			

### Dynamic Reconfiguration Port (DRP) for PLL Before and After DCLK

T <sub>PLLDCK_DADDR/T<sub>PLLCKD_DADDR</sub></sub>	DADDR setup/hold	1.25/0.15	1.40/0.15	1.63/0.15	ns, Min
T <sub>PLLDCK_DI/T<sub>PLLCKD_DI</sub></sub>	DI setup/hold	1.25/0.15	1.40/0.15	1.63/0.15	ns, Min
T <sub>PLLDCK_DEN/T<sub>PLLCKD_DEN</sub></sub>	DEN setup/hold	1.76/0.00	1.97/0.00	2.29/0.00	ns, Min
T <sub>PLLDCK_DWE/T<sub>PLLCKD_DWE</sub></sub>	DWE setup/hold	1.25/0.15	1.40/0.15	1.63/0.15	ns, Min
T <sub>PLLCKO_DRDY</sub>	CLK to out of DRDY	0.65	0.72	0.99	ns, Max
F <sub>DCK</sub>	DCLK frequency	200.00	200.00	200.00	MHz, Max

### Notes:

1. The PLL does not filter typical spread-spectrum input clocks because they are usually far below the bandwidth filter frequencies.
2. The static offset is measured between any PLL outputs with identical phase.
3. Values for this parameter are available in the Clocking Wizard.  
See [http://www.xilinx.com/products/intellectual-property/clocking\\_wizard.htm](http://www.xilinx.com/products/intellectual-property/clocking_wizard.htm).
4. Includes global clock buffer.
5. Calculated as F<sub>VCO</sub>/128 assuming output duty cycle is 50%.

## GTX Transceiver Specifications

### GTX Transceiver DC Input and Output Levels

Table 51 summarizes the DC specifications of the GTX transceivers in Virtex-7 T and XT FPGAs. Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further details.

Table 51: GTX Transceiver DC Specifications

Symbol	DC Parameter	Conditions	Min	Typ	Max	Units
$DV_{PPOUT}$	Differential peak-to-peak output voltage <sup>(1)</sup>	Transmitter output swing is set to maximum setting	—	—	1000	mV
$V_{CMOUTDC}$	DC common mode output voltage.	Equation based			$V_{MGTAVTT} - DV_{PPOUT}/4$	mV
$R_{OUT}$	Differential output resistance			100	—	$\Omega$
$T_{OSKEW}$	Transmitter output pair (TXP and TXN) intra-pair skew			2	12	ps
$DV_{PPIN}$	Differential peak-to-peak input voltage (external AC coupled)	>10.3125 Gb/s	150	—	1250	mV
		6.6 Gb/s to 10.3125 Gb/s	150	—	1250	mV
		$\leq 6.6$ Gb/s	150	—	2000	mV
$V_{IN}$	Absolute input voltage	DC coupled $V_{MGTAVTT} = 1.2V$	-200	—	$V_{MGTAVTT}$	mV
$V_{CMIN}$	Common mode input voltage	DC coupled $V_{MGTAVTT} = 1.2V$	—	$2/3 V_{MGTAVTT}$	—	mV
$R_{IN}$	Differential input resistance			100	—	$\Omega$
$C_{EXT}$	Recommended external AC coupling capacitor <sup>(2)</sup>				100	nF

**Notes:**

1. The output swing and preemphasis levels are programmable using the attributes discussed in the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)), and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

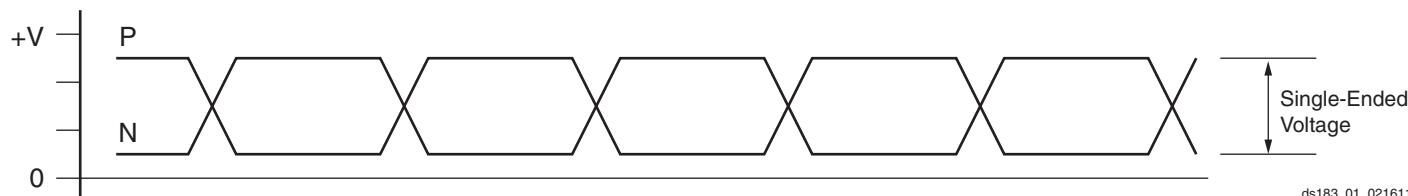


Figure 1: Single-Ended Peak-to-Peak Voltage

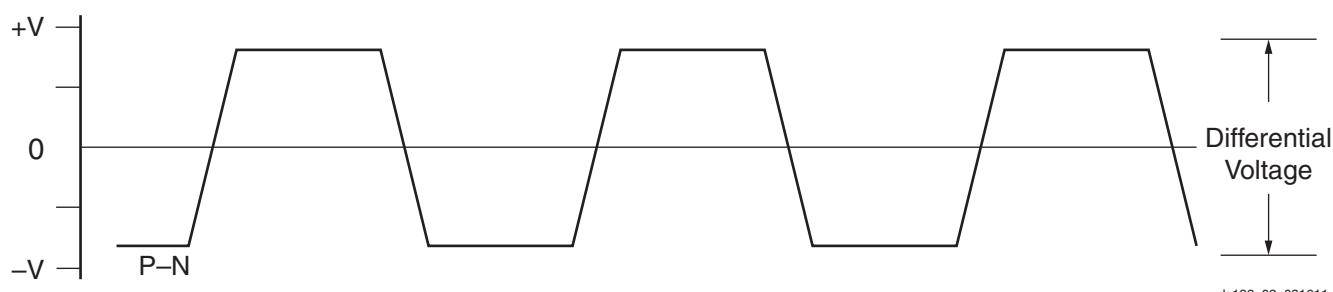


Figure 2: Differential Peak-to-Peak Voltage

**Table 52** summarizes the DC specifications of the clock input of the GTX transceiver. Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further details.

**Table 52: GTX Transceiver Clock DC Input Level Specification**

Symbol	DC Parameter	Min	Typ	Max	Units
$V_{IDIFF}$	Differential peak-to-peak input voltage	250	—	2000	mV
$R_{IN}$	Differential input resistance	—	100	—	$\Omega$
$C_{EXT}$	Required external AC coupling capacitor	—	100	—	nF

## GTX Transceiver Switching Characteristics

Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further information.

**Table 53: GTX Transceiver Performance**

Symbol	Description	Output Divider	Speed Grade			Units
			-3/-2G	-2/-2L	-1 <sup>(1)</sup>	
$F_{GTXMAX}^{(2)}$	Maximum GTX transceiver data rate	12.5	10.3125	8.0	Gb/s	
$F_{GTXMIN}^{(2)}$	Minimum GTX transceiver data rate	0.500	0.500	0.500	Gb/s	
$F_{GTXCRANGE}$	CPLL line rate range	1	3.2–6.6			Gb/s
		2	1.6–3.3			Gb/s
		4	0.8–1.65			Gb/s
		8	0.5–0.825			Gb/s
		16	N/A			Gb/s
$F_{GTXQRANGE1}$	QPLL line rate range 1	1	5.93–8.0	5.93–8.0	5.93–8.0	Gb/s
		2	2.965–4.0	2.965–4.0	2.965–4.0	Gb/s
		4	1.4825–2.0	1.4825–2.0	1.4825–2.0	Gb/s
		8	0.74125–1.0	0.74125–1.0	0.74125–1.0	Gb/s
		16	N/A	N/A	N/A	Gb/s
$F_{GTXQRANGE2}$	QPLL line rate range 2 <sup>(3)</sup>	1	9.8–12.5	9.8–10.3125	N/A	Gb/s
		2	4.9–6.25	4.9–5.15625	N/A	Gb/s
		4	2.45–3.125	2.45–2.578125	N/A	Gb/s
		8	1.225–1.5625	1.225–1.2890625	N/A	Gb/s
		16	0.6125–0.78125	0.6125–0.64453125	N/A	Gb/s
$F_{GCPLL RANGE}$	GTX transceiver CPLL frequency range	1.6–3.3	1.6–3.3	1.6–3.3	GHz	
$F_{GQPLL RANGE1}$	GTX transceiver QPLL frequency range 1	5.93–8.0	5.93–8.0	5.93–8.0	GHz	
$F_{GQPLL RANGE2}$	GTX transceiver QPLL frequency range 2	9.8–12.5	9.8–10.3125	N/A	GHz	

### Notes:

- The -1 speed grade requires a 4-byte internal data width for operation above 5.0 Gb/s. A -1 speed grade with  $V_{CCINT} = 0.9V$ , as described in the *Lowering Power using the Voltage Identification Bit* application note ([XAPP555](#)), requires a 4-byte internal data width for operation above 3.8 Gb/s.
- Data rates between 8.0 Gb/s and 9.8 Gb/s are not available.
- For QPLL line rate range 2, the maximum line rate with the divider N set to 66 is 10.3125Gb/s.

**Table 54: GTX Transceiver Dynamic Reconfiguration Port (DRP) Switching Characteristics**

Symbol	Description	Speed Grade			Units
		-3/-2G	-2/-2L	-1	
$F_{GTXDRPCLK}$	GTXDRPCLK maximum frequency	175.01	175.01	156.25	MHz

Table 55: GTX Transceiver Reference Clock Switching Characteristics

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$F_{GCLK}$	Reference clock frequency range	-3 speed grade	60	—	700	MHz
		All other speed grades	60	—	670	MHz
$T_{RCLK}$	Reference clock rise time	20% – 80%	—	200	—	ps
$T_{FCLK}$	Reference clock fall time	80% – 20%	—	200	—	ps
$T_{DCREF}$	Reference clock duty cycle	Transceiver PLL only	40	50	60	%

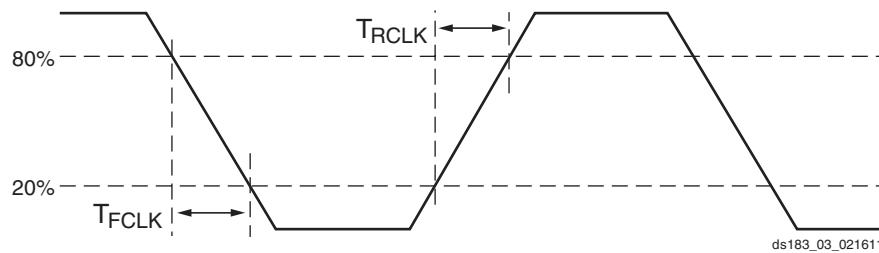


Figure 3: Reference Clock Timing Parameters

Table 56: GTX Transceiver PLL/Lock Time Adaptation

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$T_{LOCK}$	Initial PLL lock		—	—	1	ms
$T_{DLOCK}$	Clock recovery phase acquisition and adaptation time for decision feedback equalizer (DFE).	After the PLL is locked to the reference clock, this is the time it takes to lock the clock data recovery (CDR) to the data present at the input.	—	50,000	$37 \times 10^6$	UI
	Clock recovery phase acquisition and adaptation time for low-power mode (LPM) when the DFE is disabled.		—	50,000	$2.3 \times 10^6$	UI

Table 58: GTX Transceiver Transmitter Switching Characteristics (Cont'd)

Symbol	Description	Condition	Min	Typ	Max	Units
TJ <sub>6.6_CPLL</sub>	Total jitter <sup>(3)(4)</sup>	6.6 Gb/s	—	—	0.30	UI
DJ <sub>6.6_CPLL</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>5.0</sub>	Total jitter <sup>(3)(4)</sup>	5.0 Gb/s	—	—	0.30	UI
DJ <sub>5.0</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>4.25</sub>	Total jitter <sup>(3)(4)</sup>	4.25 Gb/s	—	—	0.30	UI
DJ <sub>4.25</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>3.75</sub>	Total jitter <sup>(3)(4)</sup>	3.75 Gb/s	—	—	0.30	UI
DJ <sub>3.75</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>3.20</sub>	Total jitter <sup>(3)(4)</sup>	3.20 Gb/s <sup>(5)</sup>	—	—	0.20	UI
DJ <sub>3.20</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.10	UI
TJ <sub>3.20L</sub>	Total jitter <sup>(3)(4)</sup>	3.20 Gb/s <sup>(6)</sup>	—	—	0.32	UI
DJ <sub>3.20L</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.16	UI
TJ <sub>2.5</sub>	Total jitter <sup>(3)(4)</sup>	2.5 Gb/s <sup>(7)</sup>	—	—	0.20	UI
DJ <sub>2.5</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.08	UI
TJ <sub>1.25</sub>	Total jitter <sup>(3)(4)</sup>	1.25 Gb/s <sup>(8)</sup>	—	—	0.15	UI
DJ <sub>1.25</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.06	UI
TJ <sub>500</sub>	Total jitter <sup>(3)(4)</sup>	500 Mb/s	—	—	0.10	UI
DJ <sub>500</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.03	UI

**Notes:**

1. Using same REFCLK input with TX phase alignment enabled for up to 12 consecutive transmitters (three fully populated GTX Quads).
2. Using QPLL\_FBDIV = 40, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
3. Using CPLL\_FBDIV = 2, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
4. All jitter values are based on a bit-error ratio of 1e<sup>-12</sup>.
5. CPLL frequency at 3.2 GHz and TXOUT\_DIV = 2.
6. CPLL frequency at 1.6 GHz and TXOUT\_DIV = 1.
7. CPLL frequency at 2.5 GHz and TXOUT\_DIV = 2.
8. CPLL frequency at 2.5 GHz and TXOUT\_DIV = 4.

## GTH Transceiver Specifications

### GTH Transceiver DC Input and Output Levels

Table 66 summarizes the DC specifications of the GTH transceivers in Virtex-7 T and XT FPGAs. Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further details.

Table 66: GTH Transceiver DC Specifications

Symbol	DC Parameter	Conditions	Min	Typ	Max	Units	
DV <sub>PPIN</sub>	Differential peak-to-peak input voltage (external AC coupled)	>10.3125 Gb/s	150	—	1250	mV	
		6.6 Gb/s to 10.3125 Gb/s	150	—	1250	mV	
		≤ 6.6 Gb/s	150	—	2000	mV	
V <sub>IN</sub>	Absolute input voltage	DC coupled V <sub>MGTAVTT</sub> = 1.2V	-400	—	V <sub>MGTAVTT</sub>	mV	
V <sub>CMIN</sub>	Common mode input voltage	DC coupled V <sub>MGTAVTT</sub> = 1.2V	—	2/3 V <sub>MGTAVTT</sub>	—	mV	
DV <sub>PPOUT</sub>	Differential peak-to-peak output voltage <sup>(1)</sup>	Transmitter output swing is set to 1010	—	—	800	mV	
V <sub>CMOUTDC</sub>	Common mode output voltage: DC coupled	Equation based	V <sub>MGTAVTT</sub> - DV <sub>PPOUT</sub> /4				mV
V <sub>CMOUTAC</sub>	Common mode output voltage: AC coupled	Equation based	V <sub>MGTAVTT</sub> - DV <sub>PPOUT</sub> /2				mV
R <sub>IN</sub>	Differential input resistance	—	100	—	—	Ω	
R <sub>OUT</sub>	Differential output resistance	—	100	—	—	Ω	
T <sub>OSKew</sub>	Transmitter output pair (TXP and TXN) intra-pair skew	—	—	—	10	ps	
C <sub>EXT</sub>	Recommended external AC coupling capacitor <sup>(2)</sup>	—	100	—	—	nF	

**Notes:**

1. The output swing and preemphasis levels are programmable using the attributes discussed in the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)), and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

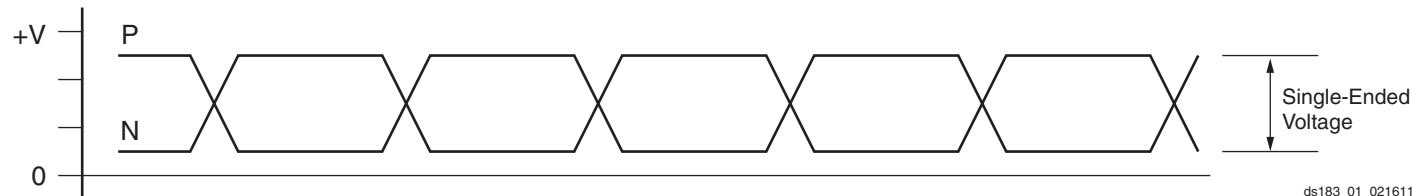


Figure 4: Single-Ended Peak-to-Peak Voltage

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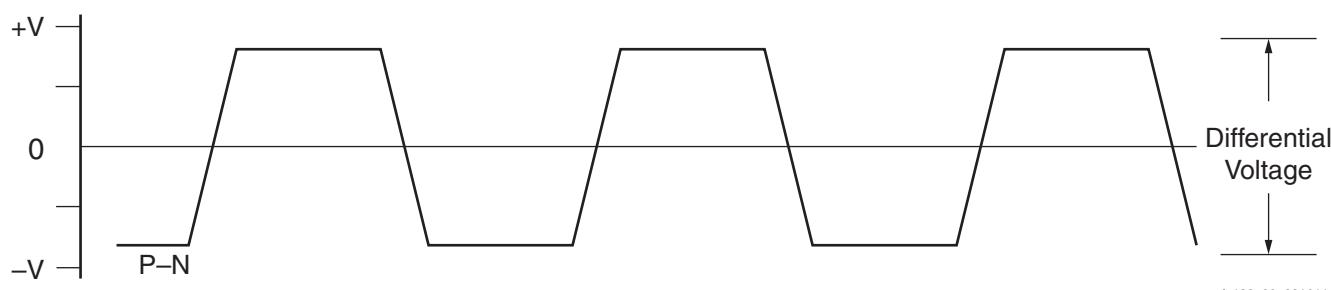


Figure 5: Differential Peak-to-Peak Voltage

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Table 70: GTH Transceiver Reference Clock Switching Characteristics

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$F_{GCLK}$	Reference clock frequency range		60	—	820	MHz
$T_{RCLK}$	Reference clock rise time	20% – 80%	—	200	—	ps
$T_{FCLK}$	Reference clock fall time	80% – 20%	—	200	—	ps
$T_{DCREF}$	Reference clock duty cycle	Transceiver PLL only	40	50	60	%

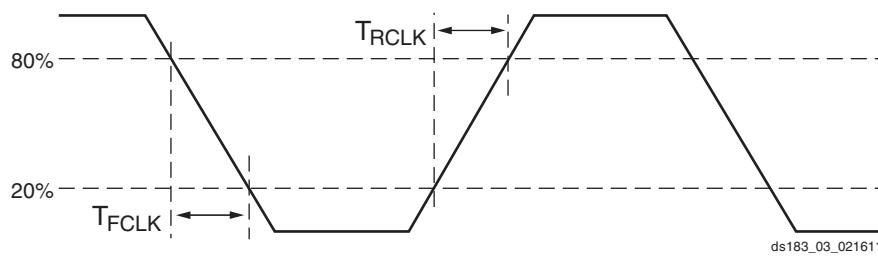


Figure 6: Reference Clock Timing Parameters

Table 71: GTH Transceiver PLL/Lock Time Adaptation

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$T_{LOCK}$	Initial PLL lock		—	—	1	ms
$T_{DLOCK}$	Clock recovery phase acquisition and adaptation time for decision feedback equalizer (DFE).	After the PLL is locked to the reference clock, this is the time it takes to lock the clock data recovery (CDR) to the data present at the input.	—	50,000	$37 \times 10^6$	UI
	Clock recovery phase acquisition and adaptation time for low-power mode (LPM) when the DFE is disabled.		—	50,000	$2.3 \times 10^6$	UI

Table 72: GTH Transceiver User Clock Switching Characteristics<sup>(1)</sup>

Symbol	Description	Data Width Conditions		Speed Grade			Units
		Internal Logic	Interconnect Logic	-3E/-2GE <sup>(2)</sup>	-2(C&I)/-2LE <sup>(2)</sup>	-1(C&I) <sup>(3)</sup>	
F <sub>TXOUT</sub>	TXUSERCLKOUT maximum frequency			412.500	412.500	312.500	MHz
F <sub>RXOUT</sub>	RXUSERCLKOUT maximum frequency			412.500	412.500	312.500	MHz
F <sub>TXIN</sub>	TXUSERCLKIN maximum frequency	16-bit	16-bit and 32-bit	412.500	412.500	312.500	MHz
		32-bit	32-bit	409.375	353.125	265.625	MHz
F <sub>RXIN</sub>	RXUSERCLKIN maximum frequency	16-bit	16-bit and 32-bit	412.500	412.500	312.500	MHz
		32-bit	32-bit	409.375	353.125	265.625	MHz
F <sub>TXIN2</sub>	TXUSERCLKIN2 maximum frequency	16-bit	16-bit	412.500	412.500	312.500	MHz
		16-bit and 32-bit	32-bit	409.375	353.125	265.625	MHz
		64-bit	64-bit	204.688	176.563	132.813	MHz
F <sub>RXIN2</sub>	RXUSERCLKIN2 maximum frequency	16-bit	16-bit	412.500	412.500	312.500	MHz
		16-bit and 32-bit	32-bit	409.375	353.125	265.625	MHz
		64-bit	64-bit	204.688	176.563	132.813	MHz

**Notes:**

- Clocking must be implemented as described in the 7 Series FPGAs GTX/GTH Transceiver User Guide ([UG476](#)).
- For speed grades -3E, -2GE, -2C, -2L, and -2LE, a 16-bit data path can only be used for speeds less than 6.6 Gb/s.
- For speed grade -1 (and when V<sub>CCINT</sub> = 0.9V), a 16-bit data path can only be used for speeds less than 5.0 Gb/s.

Table 73: GTH Transceiver Transmitter Switching Characteristics

Symbol	Description	Condition	Min	Typ	Max	Units
F <sub>GTHTX</sub>	Serial data rate range		0.500	–	F <sub>GTHMAX</sub>	Gb/s
T <sub>RTX</sub>	TX rise time	20%–80%	–	40	–	ps
T <sub>FTX</sub>	TX fall time	80%–20%	–	40	–	ps
T <sub>LLSKEW</sub>	TX lane-to-lane skew <sup>(1)</sup>		–	–	500	ps
V <sub>TXOOBVDP</sub>	Electrical idle amplitude		–	–	15	mV
T <sub>TXOOBTRANSITION</sub>	Electrical idle transition time		–	–	140	ns
TJ <sub>13.1</sub>	Total jitter <sup>(2)(4)</sup>	13.1 Gb/s	–	–	0.3	UI
DJ <sub>13.1</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>12.5</sub>	Total jitter <sup>(2)(4)</sup>	12.5 Gb/s	–	–	0.28	UI
DJ <sub>12.5</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>11.3</sub>	Total jitter <sup>(2)(4)</sup>	11.3 Gb/s	–	–	0.28	UI
DJ <sub>11.3</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>10.3125_QPLL</sub>	Total jitter <sup>(2)(4)</sup>	10.3125 Gb/s	–	–	0.28	UI
DJ <sub>10.3125_QPLL</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>10.3125_CPLL</sub>	Total jitter <sup>(3)(4)</sup>	10.3125 Gb/s	–	–	0.33	UI
DJ <sub>10.3125_CPLL</sub>	Deterministic jitter <sup>(3)(4)</sup>		–	–	0.17	UI
TJ <sub>9.953</sub>	Total jitter <sup>(2)(4)</sup>	9.953 Gb/s	–	–	0.28	UI
DJ <sub>9.953</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>9.8</sub>	Total jitter <sup>(2)(4)</sup>	9.8 Gb/s	–	–	0.28	UI
DJ <sub>9.8</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>8.0_QPLL</sub>	Total jitter <sup>(2)(4)</sup>	8.0 Gb/s	–	–	0.28	UI
DJ <sub>8.0_QPLL</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI

Table 73: GTH Transceiver Transmitter Switching Characteristics (Cont'd)

Symbol	Description	Condition	Min	Typ	Max	Units
TJ <sub>8.0_CPLL</sub>	Total jitter <sup>(3)(4)</sup>	8.0 Gb/s	—	—	0.32	UI
DJ <sub>8.0_CPLL</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.17	UI
TJ <sub>6.6_QPLL</sub>	Total jitter <sup>(2)(4)</sup>	6.6 Gb/s	—	—	0.28	UI
DJ <sub>6.6_QPLL</sub>	Deterministic jitter <sup>(2)(4)</sup>		—	—	0.17	UI
TJ <sub>6.6_CPLL</sub>	Total jitter <sup>(3)(4)</sup>	6.6 Gb/s	—	—	0.30	UI
DJ <sub>6.6_CPLL</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>5.0</sub>	Total jitter <sup>(3)(4)</sup>	5.0 Gb/s	—	—	0.30	UI
DJ <sub>5.0</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>4.25</sub>	Total jitter <sup>(3)(4)</sup>	4.25 Gb/s	—	—	0.30	UI
DJ <sub>4.25</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>3.75</sub>	Total jitter <sup>(3)(4)</sup>	3.75 Gb/s	—	—	0.30	UI
DJ <sub>3.75</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>3.20</sub>	Total jitter <sup>(3)(4)</sup>	3.20 Gb/s <sup>(5)</sup>	—	—	0.2	UI
DJ <sub>3.20</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.1	UI
TJ <sub>3.20L</sub>	Total jitter <sup>(3)(4)</sup>	3.20 Gb/s <sup>(6)</sup>	—	—	0.32	UI
DJ <sub>3.20L</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.16	UI
TJ <sub>2.5</sub>	Total jitter <sup>(3)(4)</sup>	2.5 Gb/s <sup>(7)</sup>	—	—	0.20	UI
DJ <sub>2.5</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.08	UI
TJ <sub>1.25</sub>	Total jitter <sup>(3)(4)</sup>	1.25 Gb/s <sup>(8)</sup>	—	—	0.15	UI
DJ <sub>1.25</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.06	UI
TJ <sub>500</sub>	Total jitter <sup>(3)(4)</sup>	500 Mb/s	—	—	0.1	UI
DJ <sub>500</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.03	UI

**Notes:**

1. Using same REFCLK input with TX phase alignment enabled for up to 12 consecutive transmitters (three fully populated GTH Quads).
2. Using QPLL\_FBDIV = 40, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
3. Using CPLL\_FBDIV = 2, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
4. All jitter values are based on a bit-error ratio of  $1e^{-12}$ .
5. CPLL frequency at 3.2 GHz and TXOUT\_DIV = 2.
6. CPLL frequency at 1.6 GHz and TXOUT\_DIV = 1.
7. CPLL frequency at 2.5 GHz and TXOUT\_DIV = 2.
8. CPLL frequency at 2.5 GHz and TXOUT\_DIV = 4.

## GTH Transceiver Protocol Jitter Characteristics

For Table 75 through Table 80, the 7 Series FPGAs GTX/GTH Transceiver User Guide ([UG476](#)) contains recommended settings for optimal usage of protocol specific characteristics.

**Table 75: Gigabit Ethernet Protocol Characteristics (GTH Transceivers)**

Description	Line Rate (Mb/s)	Min	Max	Units
<b>Gigabit Ethernet Transmitter Jitter Generation</b>				
Total transmitter jitter (T_TJ)	1250	–	0.24	UI
<b>Gigabit Ethernet Receiver High Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	1250	0.749	–	UI

**Table 76: XAUI Protocol Characteristics (GTH Transceivers)**

Description	Line Rate (Mb/s)	Min	Max	Units
<b>XAUI Transmitter Jitter Generation</b>				
Total transmitter jitter (T_TJ)	3125	–	0.35	UI
<b>XAUI Receiver High Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	3125	0.65	–	UI

**Table 77: PCI Express Protocol Characteristics (GTH Transceivers)<sup>(1)</sup>**

Standard	Description	Line Rate (Mb/s)	Min	Max	Units	
<b>PCI Express Transmitter Jitter Generation</b>						
PCI Express Gen 1	Total transmitter jitter	2500	–	0.25	UI	
PCI Express Gen 2	Total transmitter jitter	5000	–	0.25	UI	
PCI Express Gen 3 <sup>(2)</sup>	Total transmitter jitter uncorrelated	8000	–	31.25	ps	
	Deterministic transmitter jitter uncorrelated		–	12	ps	
<b>PCI Express Receiver High Frequency Jitter Tolerance</b>						
PCI Express Gen 1	Total receiver jitter tolerance	2500	0.65	–	UI	
PCI Express Gen 2 <sup>(3)</sup>	Receiver inherent timing error	5000	0.40	–	UI	
	Receiver inherent deterministic timing error		0.30	–	UI	
PCI Express Gen 3 <sup>(2)</sup>	Receiver sinusoidal jitter tolerance	0.03 MHz–1.0 MHz	8000	1.00	–	UI
		1.0 MHz–10 MHz		Note 4	–	UI
		10 MHz–100 MHz		0.10	–	UI

### Notes:

1. Tested per card electromechanical (CEM) methodology.
2. PCI-SIG 3.0 certification and compliance test boards are currently not available.
3. Using common REFCLK.
4. Between 1 MHz and 10 MHz the minimum sinusoidal jitter roll-off with a slope of 20dB/decade.

Table 78: CEI-6G and CEI-11G Protocol Characteristics (GTH Transceivers)

Description	Line Rate (Mb/s)	Interface	Min	Max	Units
<b>CEI-6G Transmitter Jitter Generation</b>					
Total transmitter jitter <sup>(1)</sup>	4976–6375	CEI-6G-SR	–	0.3	UI
		CEI-6G-LR	–	0.3	UI
<b>CEI-6G Receiver High Frequency Jitter Tolerance</b>					
Total receiver jitter tolerance <sup>(1)</sup>	4976–6375	CEI-6G-SR	0.6	–	UI
		CEI-6G-LR	0.95	–	UI
<b>CEI-11G Transmitter Jitter Generation</b>					
Total transmitter jitter <sup>(2)</sup>	9950–11100	CEI-11G-SR	–	0.3	UI
		CEI-11G-LR/MR	–	0.3	UI
<b>CEI-11G Receiver High Frequency Jitter Tolerance</b>					
Total receiver jitter tolerance <sup>(2)</sup>	9950–11100	CEI-11G-SR	0.65	–	UI
		CEI-11G-MR	0.65	–	UI
		CEI-11G-LR	0.825	–	UI

**Notes:**

1. Tested at most commonly used line rate of 6250 Mb/s using 390.625 MHz reference clock.
2. Tested at line rate of 9950 Mb/s using 155.46875 MHz reference clock and 11100 Mb/s using 173.4375 MHz reference clock.

Table 79: SFP+ Protocol Characteristics (GTH Transceivers)

Description	Line Rate (Mb/s)	Min	Max	Units
<b>SFP+ Transmitter Jitter Generation</b>				
Total transmitter jitter	9830.40 <sup>(1)</sup>	–	0.28	UI
	9953.00			
	10312.50			
	10518.75			
	11100.00			
<b>SFP+ Receiver Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	9830.40 <sup>(1)</sup>	0.7	–	UI
	9953.00			
	10312.50			
	10518.75			
	11100.00			

**Notes:**

1. Line rated used for CPRI over SFP+ applications.

Table 82: XADC Specifications (Cont'd)

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
<b>XADC Reference<sup>(5)</sup></b>						
External Reference	V <sub>REFP</sub>	Externally supplied reference voltage	1.20	1.25	1.30	V
On-Chip Reference		Ground V <sub>REFP</sub> pin to AGND, T <sub>j</sub> = -40°C to 100°C	1.2375	1.25	1.2625	V

**Notes:**

- Offset and gain errors are removed by enabling the XADC automatic gain calibration feature. The values are specified for when this feature is enabled.
- Only specified for new BitGen option XADCEnhancedLinearity = ON.
- For a detailed description, see the ADC chapter in the *7 Series FPGAs and Zynq-7000 AP SoC XADC Dual 12-Bit 1 MSPS Analog-to-Digital Converter* ([UG480](#)).
- For a detailed description, see the Timing chapter in the *7 Series FPGAs and Zynq-7000 AP SoC XADC Dual 12-Bit 1 MSPS Analog-to-Digital Converter* ([UG480](#)).
- Any variation in the reference voltage from the nominal V<sub>REFP</sub> = 1.25V and V<sub>REFN</sub> = 0V will result in a deviation from the ideal transfer function. This also impacts the accuracy of the internal sensor measurements (i.e., temperature and power supply). However, for external ratio metric type applications allowing reference to vary by ±4% is permitted. On-chip reference variation is ±1%.

## Configuration Switching Characteristics

Table 83: Configuration Switching Characteristics

Symbol	Description	Virtex-7 T and XT Devices	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
<b>Power-up Timing Characteristics</b>						
T <sub>PL</sub> <sup>(1)</sup>	Program latency		5	5	5	ms, Max
T <sub>POR</sub> <sup>(1)</sup>	Power-on reset (50ms ramp rate time)	10/50	10/50	10/50	ms, Min/Max	
	Power-on reset (1ms ramp rate time)	10/35	10/35	10/35	ms, Min/Max	
T <sub>PROGRAM</sub>	Program pulse width	250	250	250	ns, Min	
<b>CCLK Output (Master Mode)</b>						
T <sub>ICCK</sub>	Master CCLK output delay	150	150	150	ns, Min	
T <sub>MCCKL</sub>	Master CCLK clock Low time duty cycle	40/60	40/60	40/60	%, Min/Max	
T <sub>MCCKH</sub>	Master CCLK clock High time duty cycle	40/60	40/60	40/60	%, Min/Max	
F <sub>MCCK</sub>	Master CCLK frequency	100	100	100	MHz, Max	
	Master CCLK frequency for AES encrypted x16	50	50	50	MHz, Max	
F <sub>MCCK_START</sub>	Master CCLK frequency at start of configuration	3	3	3	MHz, Typ	
F <sub>MCCKTOL</sub>	Frequency tolerance, master mode with respect to nominal CCLK.	±50	±50	±50	%, Max	
<b>CCLK Input (Slave Modes)</b>						
T <sub>SCCKL</sub>	Slave CCLK clock minimum Low time	2.5	2.5	2.5	ns, Min	
T <sub>SCCKH</sub>	Slave CCLK clock minimum High time	2.5	2.5	2.5	ns, Min	
F <sub>SCCK</sub>	Slave CCLK frequency	100	100	100	MHz, Max	
<b>EMCCLK Input (Master Mode)</b>						
T <sub>EMCCKL</sub>	External master CCLK Low time	2.5	2.5	2.5	ns, Min	
T <sub>EMCCKH</sub>	External master CCLK High time	2.5	2.5	2.5	ns, Min	
F <sub>EMCCK</sub>	External master CCLK frequency	100	100	100	MHz, Max	
<b>Internal Configuration Access Port</b>						
F <sub>ICAPCK</sub>	Internal configuration access port (ICAPE2)	100.00	100.00	100.00	MHz, Max	